FIG. 1A

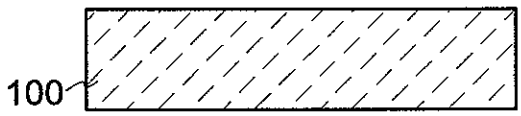


FIG. 1B

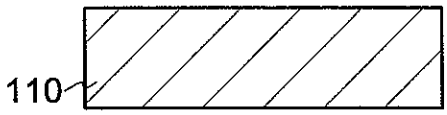


FIG. 1C

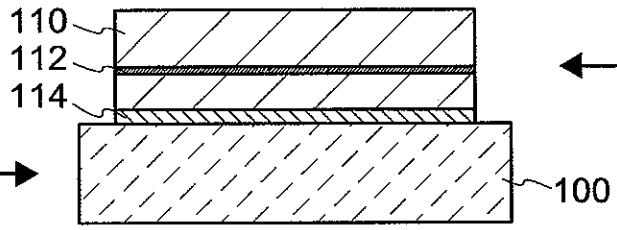
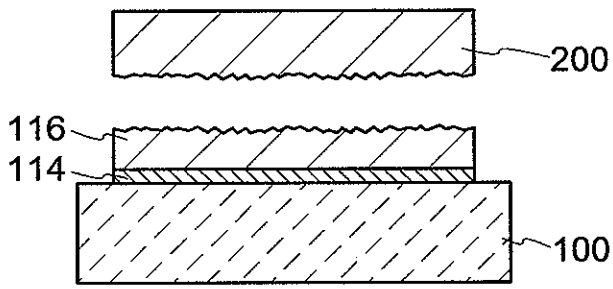


FIG. 1D



Reprocessing Process

FIG. 1E

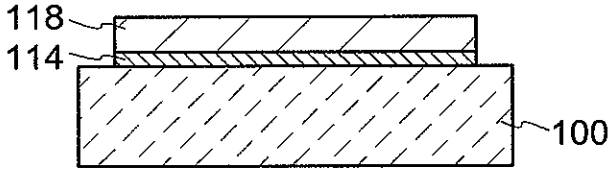


FIG. 2

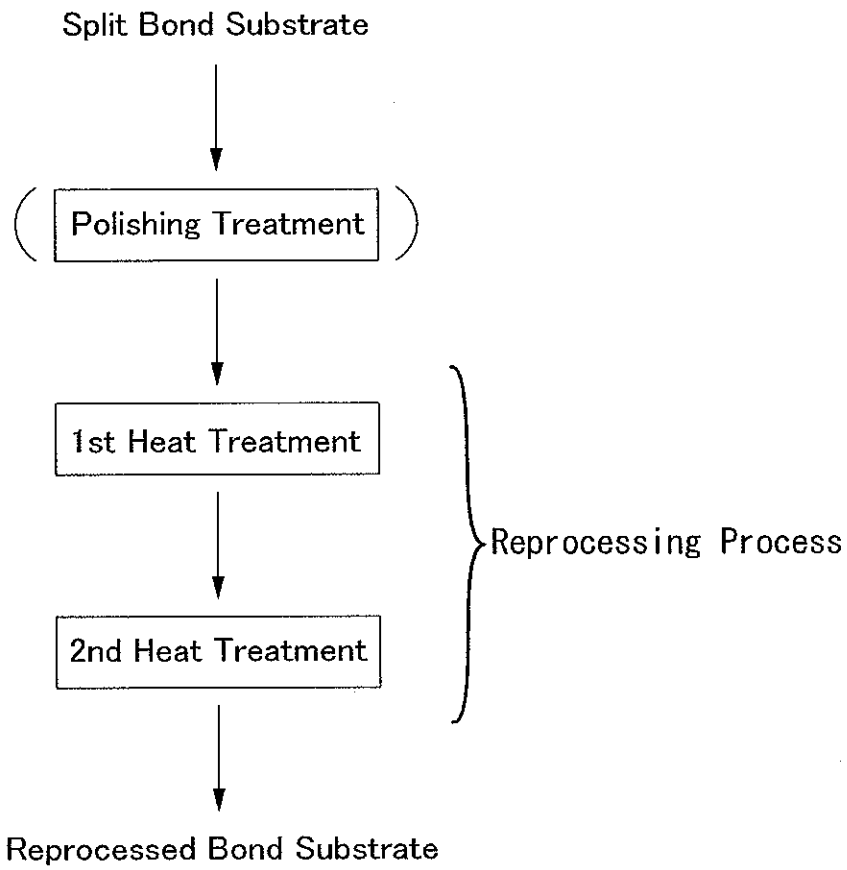

Split Bond Substrate
Polishing Treatment
1st Heat Treatment
2nd Heat Treatment
Reprocessing Process
Reprocessed Bond Substrate

FIG. 3A

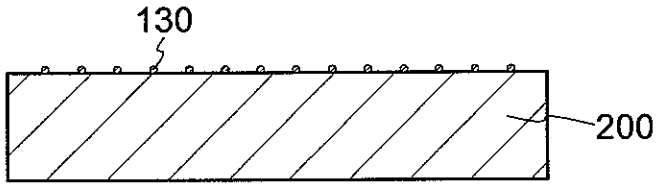


FIG. 3B

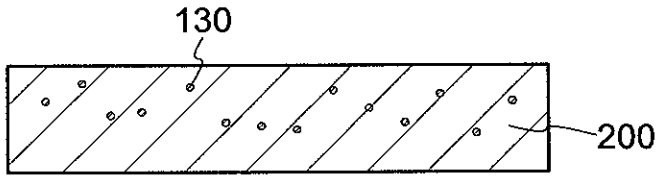


FIG. 3C

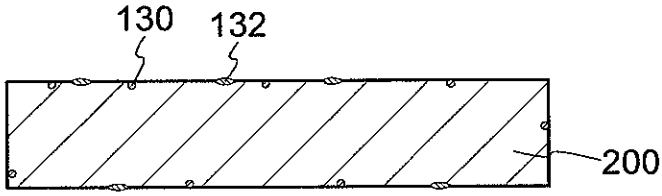


FIG. 3D

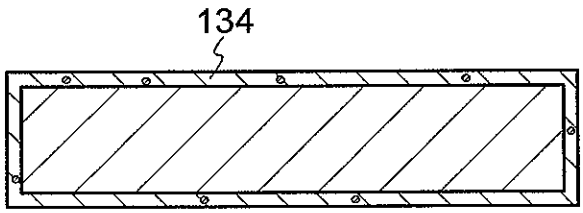


FIG. 3E

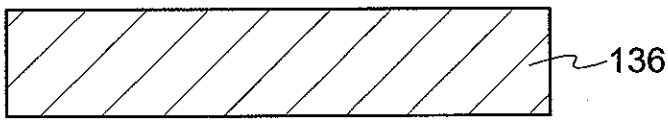


FIG. 4A

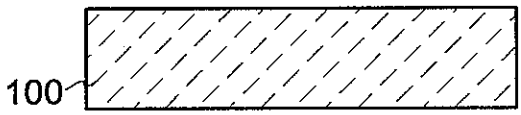


FIG. 4B-1

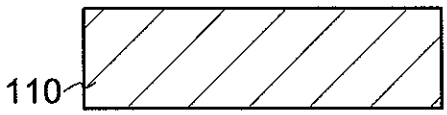


FIG. 4B-2

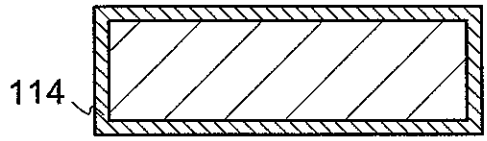


FIG. 4B-3

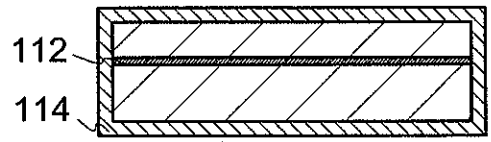


FIG. 4C

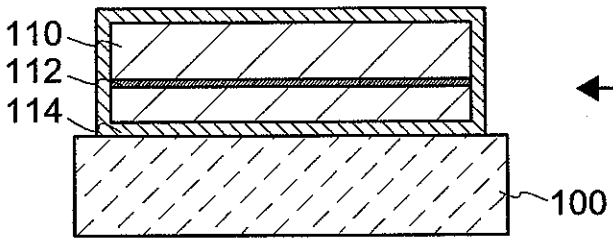
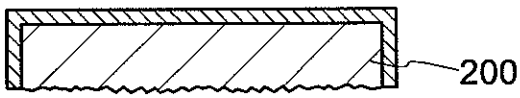


FIG. 4D



Reprocessing Process

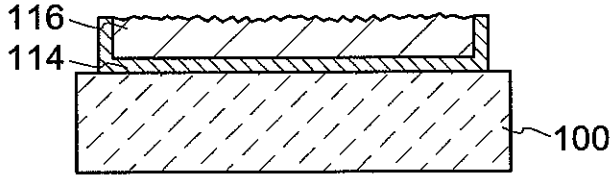


FIG. 4E

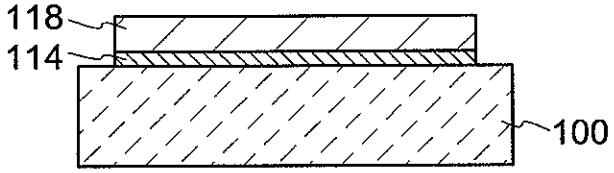


FIG. 5A-1

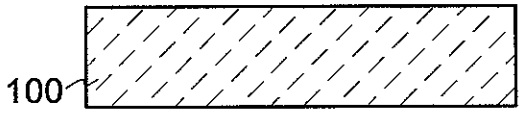


FIG. 5A-2

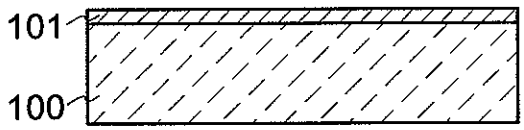


FIG. 5B-1



FIG. 5B-2

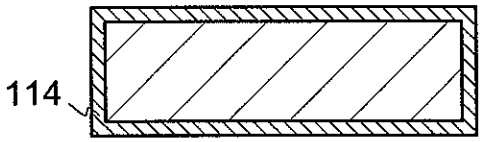


FIG. 5B-3

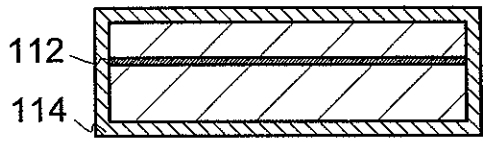


FIG. 5C

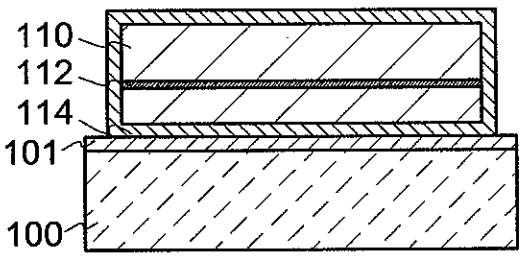
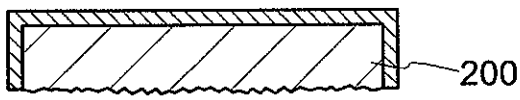


FIG. 5D



Reprocessing Process

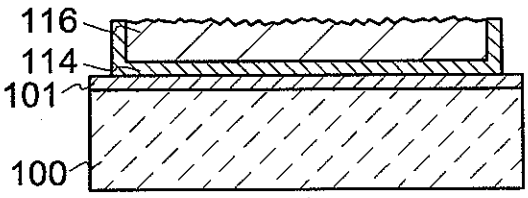


FIG. 5E

